Vishay Siliconix

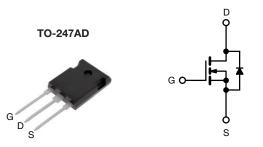
AUTOMOTIVE GRADE

RoHS

COMPLIANT

HALOGEN FREE

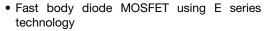
E Series Power MOSFET With Fast Body Diode

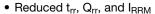


N-Channel MOSFET

PRODUCT SUMMARY						
V _{DS} (V) at T _J max.	700					
R _{DS(on)} typ. (Ω) at 25 °C	V _{GS} = 10 V 0.095					
Q _g typ. (nC)	115					
Q _{gs} (nC)	26					
Q _{gd} (nC)	44					
Configuration	Single					

FEATURES





- Low figure-of-merit (FOM): Ron x Qa
- Low input capacitance (C_{iss})
- Low switching losses due to reduced Q_{rr}
- 175 °C operating temperature
- AEC-Q101 qualified
- Ultra low gate charge (Q_a)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- · Automotive onboard charger
- Automotive DC/DC converter

ORDERING INFORMATION	
Package	TO-247AD
Lead (Pb)-free and halogen-free	SQW33N65EF-GE3

ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted)							
PARAMETER			SYMBOL	LIMIT	UNIT		
Drain-source voltage			V_{DS}	650			
Gate-source voltage			V_{GS}	± 30	V		
Continuous drain current (T _J = 150 °C)	V _{GS} at 10 V	T _C = 25 °C	- I _D	34	А		
	V _{GS} at 10 V	T _C = 100 °C		24			
Pulsed drain current ^a			I _{DM}	95	1		
Linear derating factor				2.5	W/°C		
Single pulse avalanche energy b	E _{AS}	508	mJ				
Maximum power dissipation			P_{D}	375	W		
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +175	°C		
Drain-source voltage slope			dV/dt	100	V/ns		
Reverse diode dV/dt d	50						
Soldering recommendations (peak temperature) c For 10 s				260	°C		

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature
- b. V_{DD} = 140 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 Ω , I_{AS} = 6.0 A
- c. 1.6 mm from case
- d. $I_{SD} \le I_D$, $dI/dt = 160 \text{ A/}\mu\text{s}$, starting $T_J = 25 \,^{\circ}\text{C}$

THERMAL RESISTANCE RATINGS						
PARAMETER	SYMBOL	TYP.	MAX.	UNIT		
Maximum junction-to-ambient	R _{thJA}	-	40	°C/W		
Maximum junction-to-case (drain)	R_{thJC}	-	0.4			



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PARAMETER	SYMBOL	TES	TEST CONDITIONS		TYP.	MAX.	UNIT
Static					•		
Drain-source breakdown voltage	V_{DS}	V _{GS} :	= 0 V, I _D = 250 μA	650	-	=.	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C, I _D = 10 mA	-	0.69	-	V/°C
Gate-source threshold voltage (N)	V _{GS(th)}	V _{DS} =	- V _{GS} , I _D = 250 μA	2.0	-	4.0	V
Coto pouros loskogo		$V_{GS} = \pm 20 \text{ V}$ $V_{GS} = \pm 30 \text{ V}$		-	-	± 100	nA
Gate-source leakage	I _{GSS}			-	-	± 1	μΑ
Zoro goto voltago droin ourrent		V _{DS} =	= 520 V, V _{GS} = 0 V	-	-	1	
Zero gate voltage drain current	I _{DSS}	V _{DS} = 520 \	['] , V _{GS} = 0 V, T _J = 125 °C	-	-	500	μA
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 16.5 A	-	0.095	0.109	Ω
Forward transconductance ^a	9 _{fs}	V _{DS} =	30 V, I _D = 16.5 A	-	13	=.	S
Dynamic							
Input capacitance	C _{iss}		$V_{GS} = 0 V$	-	3972	-	
Output capacitance	C _{oss}		V _{DS} = 100 V,	-	163	=.	
Reverse transfer capacitance	C _{rss}	f = 1 MHz		-	5	=.	pF
Effective output capacitance, energy related ^a	C _{o(er)}	V _{GS} = 0 V, V _{DS} = 0 V to 520 V		-	117	-	
Effective output capacitance, time related b	C _{o(tr)}		. 43 - 1, 1, 1, 1, 1, 1, 1, 1, 1, 1, 1, 1, 1,		482	-	
Total gate charge	Qg			-	115	173	
Gate-source charge	Q_{gs}	$V_{GS} = 10 \text{ V}$	$V_{GS} = 10 \text{ V}$ $I_D = 16.5 \text{ A}, V_{DS} = 520 \text{ V}$		26	=.	nC
Gate-drain charge	Q_{gd}			-	44	-	
Turn-on delay time	t _{d(on)}	$V_{DD} = 520 \text{ V}, I_{D} = 16.5 \text{ A}$ $R_{g} = 9.1 \Omega, V_{GS} = 10 \text{ V}$		-	32	64	
Rise time	t _r			-	51	77	- ns
Turn-off delay time	t _{d(off)}			-	134	201	
Fall time	t _f			-	62	93	
Gate input resistance	R_g	f = 1 MHz, open drain		0.4	0.9	1.8	Ω
Drain-Source Body Diode Characteristics							
Continuous source-drain diode current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	34	
Pulsed diode forward current	I _{SM}			-	-	95	- A
Diode forward voltage	V _{SD}	T _J = 25 °C, I _S = 16.5 A, V _{GS} = 0 V		-	0.9	1.2	٧
Reverse recovery time	t _{rr}	T _J = 25 °C, I _F = I _S = 16.5 A, dl/dt = 100 A/µs, V _R = 400 V		-	178	356	ns
Reverse recovery charge	Q _{rr}			-	1.4	2.8	μC
Reverse recovery current	I _{RRM}			_	17	-	A

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DS}

b. $C_{oss(tr)}$ is a fixed capacitance that gives the charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DS}



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

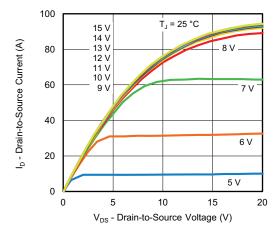


Fig. 1 - Typical Output Characteristics

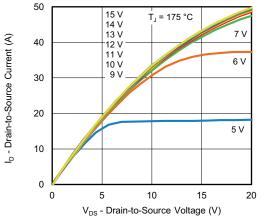


Fig. 2 - Typical Output Characteristics

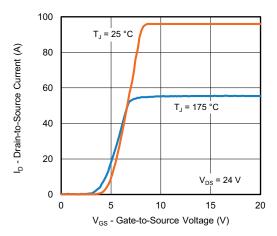


Fig. 3 - Typical Transfer Characteristics

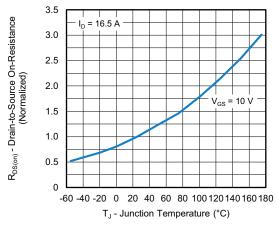


Fig. 4 - Normalized On-Resistance vs. Temperature

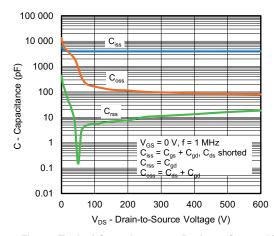


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

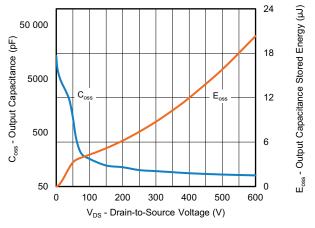


Fig. 6 - Coss and Eoss vs. V_{DS}



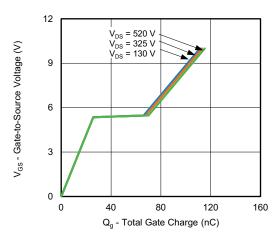


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

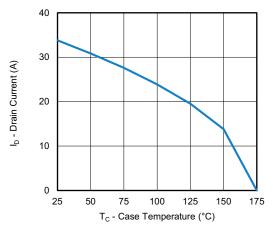


Fig. 10 - Maximum Drain Current vs. Case Temperature

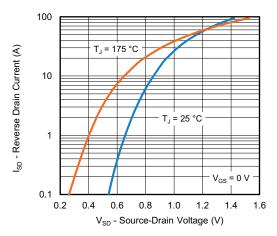


Fig. 8 - Typical Source-Drain Diode Forward Voltage

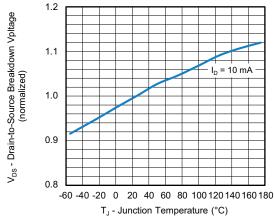


Fig. 11 - Typical Drain-to-Source Voltage vs. Temperature

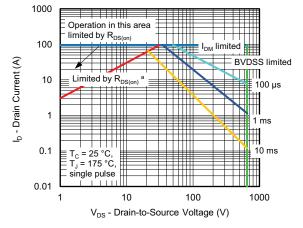


Fig. 9 - Maximum Safe Operating Area



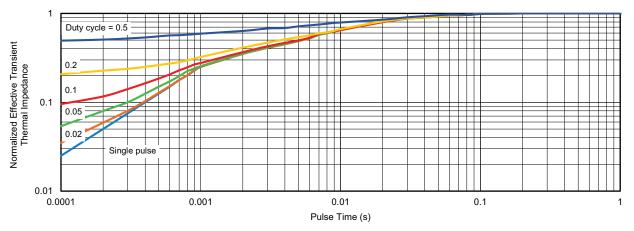


Fig. 12 - Normalized Thermal Transient Impedance, Junction-to-Case

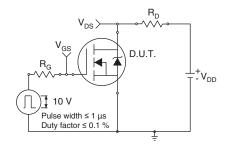


Fig. 13 - Switching Time Test Circuit

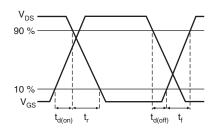


Fig. 14 - Switching Time Waveforms

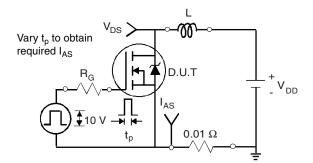


Fig. 15 - Unclamped Inductive Test Circuit

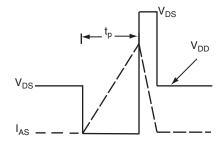


Fig. 16 - Unclamped Inductive Waveforms

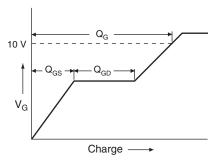


Fig. 17 - Basic Gate Charge Waveform

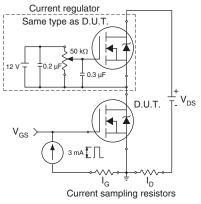
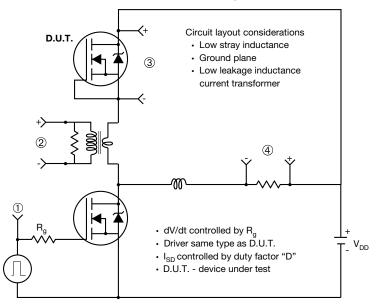


Fig. 18 - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit



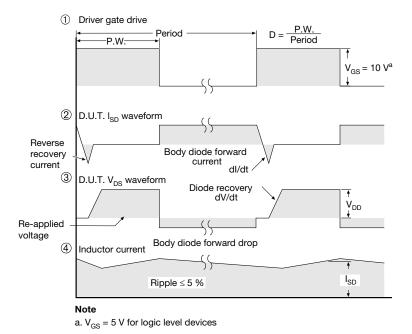
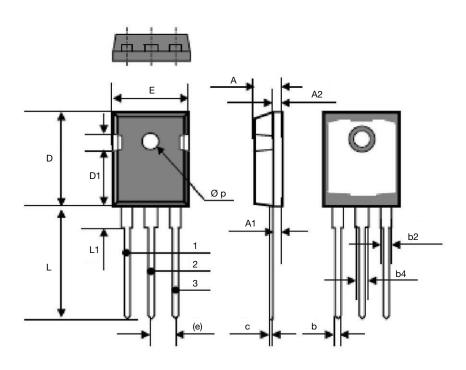


Fig. 19 - For N-Channel

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TO-247AD (High Voltage)



DIM.	MILLII	METERS	INCHES			
	MIN.	MAX.	MIN.	MAX.		
Α	4.70	5.31	0.185	0.209		
A1	2.21	2.59	0.087	0.102		
A2	1.50	2.49	0.059	0.098		
b	0.99	1.40	0.039	0.055		
b2	1.65	2.41	0.065	0.095		
b4	2.59	3.43	0.102	0.135		
С	0.6	0.61 BSC		0.024 BSC		
D	20.80	21.46	0.819	0.845		
D1	3.68	5.49	0.145	0.216		
(e)	5.46 BSC		0.215 BSC			
Е	15.49	16.26	0.610	0.640		
L	19.81	20.32	0.780	0.800		
L1	4.06	4.50	0.160	0.177		
Øр	3.51	3.66	0.138	0.144		
ECN: S17-0178-Rev. B, 0	06-Feb-17	•	•			

ECN: S17-U178-Rev. B, U6-Feb-17

DWG: 6010



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